

Docket No.: 3273-0208PUS1  
(PATENT)

*IN THE UNITED STATES PATENT AND TRADEMARK OFFICE*

In re Patent Application of:  
Hisashi MAESHIMA, *et al.*

Application No.: 10/526,672

Confirmation No.: 3246

Filed: March 4, 2005

Art Unit: 1796

For: PROCESS FOR PREPARATION OF  
ALICYCLIC DIEPOXY COMPOUNDS,  
CURABLE EPOXY RESIN COMPOSITIONS,  
EPOXY RESIN COMPOSITIONS FOR THE  
ENCAPSULATION OF ELECTRONIC PARTS,  
STABILIZERS FOR ELECTRICAL  
INSULATING OILS, AND CASTING EPOXY  
RESIN COMPOSITIONS FOR ELECTRICAL  
INSULATION

Examiner: Robert SELLERS

**AMENDMENT UNDER 37 CFR 1.116**

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

Sir:

In reply to the Office Action dated April 23, 2008, the following amendments and remarks are respectfully submitted in connection with the above-identified application.

This reply includes:

Amended Claim Set; and  
Remarks.